

I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO: MAIL STOP: OFFICE OF PUBLICATIONS, COMMISSIONER FOR PATENTS, P.O. BOX 1450, ALEXANDRIA, VA 22313-1450, ON THE DATE INDICATED BELOW.

BY: Lara Jomm

DATE: July 28, 2004

PATENT

OFFICE OF PUBLICATIONS
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re:	Patent Application of	:	
	Noboru Higashi et al.	:	
		:	Group Art Unit 2877
Conf. No.:	7117	:	
		:	
Appln. No.:	09/916,181	:	Allowed: March 1, 2004
Patent No.:	US 6,765,667 B2	:	Issued: July 20, 2004
		:	
Filed:	July 26, 2001	:	
		:	
For:	METHOD FOR INSPECTION OF	:	Attorney Docket No.
	CIRCUIT BOARDS AND	:	No. 8861-413US
	APPARATUS FOR INPECTION OF	:	(P26315-01)
	CIRCUIT BOARDS	:	

TRANSMITTAL LETTER

Although it is Applicants' opinion that the claims filed by way of amendment are substantially embraced in the statement of invention or in the claims originally filed, Applicant's herewith file a Supplemental Declaration for precautionary purposes under 37 CFR 1.67.

Respectfully submitted,

NOBORU HIGASHI ET AL.

7/28/04
Date

By: 

LOUIS SICKLES II

Registration No. 45,803

AKIN, GUMP, STRAUSS, HAUER & FELD, L.L.P.

One Commerce Square

2005 Market Street - Suite 2200

Philadelphia, PA 19103

Telephone: (215) 965-1200

Direct Dial: (215) 965-1294

Facsimile: (215) 965-1210

E-Mail: lsickles@akingump.com

LS/TMF
Enclosure

SUPPLEMENTAL DECLARATION
(Original Application)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed, as amended by any and all amendments entered during the prosecution of the patent application identified herein, and for which a patent is sought on the invention entitled **METHOD FOR INSPECTION OF CIRCUIT BOARDS AND APPARATUS FOR INSPECTION OF CIRCUIT BOARDS** the specification of which was filed on **July 26, 2001** as Application No. **09/916,181**.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any and all amendments entered during the prosecution of the application.

I acknowledge the duty to disclose information which is material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole
or first inventor **Noboru HIGASHI**

Inventor's Signature *Noboru Higashi*

Date April 20, 2004

Residence Matsuyama-shi, Japan

Citizenship Japanese
Post Office Address 638-4, Takanoko-machi,
Matsuyama-shi, Ehime 790-0925
Japan

Full name of second joint
inventor, if any **Daisuke NAGAI**

Inventor's Signature Daisuke Nagai

Date April 20, 2004

Residence Shuso-gun, Ehime Japan

Citizenship Japanese

Post Office Address 691, Nagano, Tanbara-cho,
Shuso-gun, Ehime 791-0521 Japan

Full name of third joint
inventor, if any **Kenichi KAIDA**

Inventor's Signature Kenichi Kaida

Date April 20, 2004

Residence Matsuyama-shi, Japan

Citizenship Japanese

Post Office Address 1-7-13, Yunoyama, Matsuyama-shi,
Ehime 791-0121 Japan